



Integrated Device Technology, Inc.
 6024 Silver Creek Valley Road
 San Jose, CA 96138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: W1101-02 DATE: March 16, 2011 Product Affected: Refer Attachment II. Date Effective: June 14, 2011	MEANS OF DISTINGUISHING CHANGED DEVICES: <input checked="" type="checkbox"/> Product Mark Assembly lot# and Date Code <input type="checkbox"/> Back Mark <input type="checkbox"/> Date Code <input type="checkbox"/> Other
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Contact: Bimla Paul Title: Product Quality Assurance Phone #: (408) 574-6419 Fax #: (408) 284-8362 E-mail: Bimla.Paul@idt.com	Attachment: <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No Samples: Available in June
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DESCRIPTION AND PURPOSE OF CHANGE:

<input type="checkbox"/> Die Technology	
<input type="checkbox"/> Wafer Fabrication Process	This is an advance notification to advise our customer that IDT is in the process of transferring the wafer fabrication from IDT Hillsboro, Oregon (Fab 4) to Taiwan Semiconductor Manufacturing Corporation (TSMC).
<input type="checkbox"/> Assembly Process	
<input type="checkbox"/> Equipment	
<input type="checkbox"/> Material	There is no expected change to the data sheet, package or backend manufacturing process.
<input type="checkbox"/> Testing	
<input checked="" type="checkbox"/> Manufacturing Site	Production at IDT Hillsboro, Oregon (Fab 4) is expected to continue through August 2011.
<input type="checkbox"/> Data Sheet	
<input type="checkbox"/> Other	Please refer to attachment II for affected part# list.

RELIABILITY/QUALIFICATION SUMMARY:
 Wafer and Component level Qualification and Characterization tests will verify that there is no change to the performance or reliability of the product.

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:
 IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.
 IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____	<input type="checkbox"/> <i>Approval for shipments prior to effective date.</i>
Name/Date: _____	E-Mail Address: _____
Title: _____	Phone# /Fax# : _____
CUSTOMER COMMENTS: _____	

IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: _____ DATE: _____



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ATTACHMENT I - PCN # : W1101-02

PCN Type: Wafer Fab Manufacturing Site Change - IDT Fab 4 to TSMC

Data Sheet Change: None

Detail Of Change:

This is an advance notification to advise our customer that IDT is in the process of transferring the wafer fabrication from IDT Hillsboro, Oregon (Fab 4) to Taiwan Semiconductor Manufacturing Corporation (TSMC).

There is no expected change to the data sheet, package or backend manufacturing process.

Production at IDT Hillsboro, Oregon (Fab 4) is expected to continue through August 2011.

IDT will issue a revised PCN with qualification data and PCN affectivity date once qual has been successfully completed. Please review this advance notification and contact your local IDT sales representative for sample orders.

Please refer to attachment II for affected part# list.



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ATTACHMENT II - PCN # : W1101-02

Affected Part Number

Part Number	Part Number	Part Number	Part Number
1337ACSRI	1338-18DVGI8	1338C-31SRI	1339A-31DVGI8
1337ACSRI8	1338-31DCGI	1338C-31SRI8	1339AC-31SRI
1337GCSRI	1338-31DCGI8	1339-2DCGI	1339AC-31SRI8
1337GCSRI8	1338-31DVGI	1339-2DCGI8	1339C-2SRI
1337GDCGI	1338-31DVGI8	1339-2DVGI	1339C-2SRI8
1337GDCGI8	1338A-31DVGI	1339-2DVGI8	1339C-31SRI
1337GDVGI	1338A-31DVGI8	1339-31DCGI	1339C-31SRI8
1337GDVGI8	1338AC-31SRI	1339-31DCGI8	5P90005CDCGI
1338-18DCGI	1338AC-31SRI8	1339-31DVGI	5P90005CDCGI8
1338-18DCGI8	1338C-18SRI	1339-31DVGI8	
1338-18DVGI	1338C-18SRI8	1339A-31DVGI	